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April 19, 2007

Ms. Marlene Dortch  
Secretary  
Federal Communications Commission  
445 12<sup>th</sup> Street, S.W.  
Washington, DC 20554

**Re: Oral Ex Parte Presentation Regarding ET Docket No. 03-137**

Dear Ms. Dortch:

This is to report that yesterday, April 18, 2007, Paul Guckian of QUALCOMM, Keith Hendrickson of Dell, Robin Castelle of HP, Barry Pate and Jim Salembier of Lenovo, and I met with Julius Knapp, Ira Keltz, Bruce Romano, Ron Chase, and Ed Mantiply of the Office of Engineering and Technology regarding the above-referenced proceeding. In addition, Rashmi Doshi, Tim Harrington, Kwok Chan, and Joe Dichoso of the Laboratory Division of the Office of Engineering and Technology participated in the meeting by video conference. Filed herewith is a copy of the presentation that was made at the meeting.

During the meeting, we emphasized the need for the Commission to adopt promptly a streamlined process for the issuance of equipment authorizations for notebook computer models with embedded 3G capabilities, and we referenced the proposal that QUALCOMM filed with the FCC on August 15, 2005 in this proceeding. We explained that this streamlining is necessary so that new products can be brought to market more quickly and at lower costs.

Respectfully submitted,

/s/ Dean R. Brenner

Dean R. Brenner  
Vice President, Government Affairs

Cc: Julius Knapp  
Ira Keltz  
Bruce Romano  
Ron Chase  
Ed Mantiply  
Rashmi Doshi  
Tim Harrington  
Kwok Chan  
Joe Dichoso